# Safety Recognized/High Voltage Ceramic Capacitors



# DEC Series (Class 1, 2/DC6.3kV)

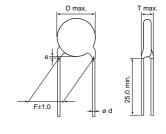
#### ■ Features

- 1. Coated with flame-retardant epoxy resin (equivalent to UL94V-0 standard).
- 2. Available product for RoHS Restriction (EU Directive 2002/95/EC).

#### Applications

- 1. Ideal for use as the ballast in back lighting inverters for liquid crystal displays (SL Char.).
- 2. Ideal for use on high voltage circuits such as Cockcroft circuits (B Char.).





(in mm)

Lead Code Coating Extension e ø d 0.6±0.05

#### ■ Marking

Temp. Char. Nominal Body Diameter	SL	В	E	
ø7mm	(5D 6KV			
ø8-9mm	47J 6KV 66	331K 6KV 66		
ø10-15mm	151J 6KV (M 66	B 102K 6KV (M 66	222Z 6KV (M66	
Temperature Characteristics	Marked with code for char. B (	omitted for nominal body diameter	ø9mm and under)	
Nominal Capacitance	Under 100pF: Actual value, 10	0pF and over: Marked with 3 figur	es	
Capacitance Tolerance	Marked with code			
Rated Voltage	Marked with code (In case of DC6.3kV, marked with 6KV)			
Manufacturer's Identification	Marked with (M) (omitted for nominal body diameter ø9mm and under)			
Manufactured Date Code	Code Abbreviation (omitted for nominal body diameter ø7mm)			

#### **SL Characteristics**

Part Number	DC Rated Voltage (Vdc)	Capacitance (pF)	Body Dia. D (mm)	Lead Spacing F (mm)	Body Thickness T (mm)
DEC1X3J050DC4BMS1	6300	5 ±0.5pF	7	10.0	7.0
DEC1X3J100JC4BMS1	6300	10 ±5%	7	10.0	7.0
DEC1X3J120JC4B	6300	12 ±5%	8	10.0	7.0
DEC1X3J150JC4B	6300	15 ±5%	8	10.0	7.0
DEC1X3J180JC4B	6300	18 ±5%	9	10.0	7.0
DEC1X3J220JC4B	6300	22 ±5%	9	10.0	7.0
DEC1X3J270JC4B	6300	27 ±5%	9	10.0	7.0
DEC1X3J330JC4B	6300	33 ±5%	9	10.0	7.0
DEC1X3J390JC4B	6300	39 ±5%	9	10.0	7.0
DEC1X3J470JC4B	6300	47 ±5%	9	10.0	7.0
DEC1X3J560JC4B	6300	56 ±5%	10	10.0	7.0
DEC1X3J680JC4B	6300	68 ±5%	12	10.0	7.0
DEC1X3J820JC4B	6300	82 ±5%	12	10.0	7.0
DEC1X3J101JC4B	6300	100 ±5%	13	10.0	7.0
DEC1X3J121JC4B	6300	120 ±5%	14	10.0	7.0
DEC1X3J151JC4B	6300	150 ±5%	15	10.0	7.0

# **B** Characteristics

Part Number	DC Rated Voltage (Vdc)	Capacitance (pF)	Body Dia. D (mm)	Lead Spacing F (mm)	Body Thickness T (mm)
DECB33J101KC4B	6300	100 ±10%	9	10.0	7.0
DECB33J151KC4B	6300	150 ±10%	9	10.0	7.0
DECB33J221KC4B	6300	220 ±10%	9	10.0	7.0
DECB33J331KC4B	6300	330 ±10%	9	10.0	7.0
DECB33J471KC4B	6300	470 ±10%	10	10.0	7.0
DECB33J681KC4B	6300	680 ±10%	11	10.0	7.0
DECB33J102KC4B	6300	1000 ±10%	13	10.0	7.0

# **E Characteristics**

Part Number	DC Rated Voltage (Vdc)	Capacitance (pF)	Body Dia. D (mm)	Lead Spacing F (mm)	Body Thickness T (mm)
DECE33J102ZC4B	6300	1000 +80/-20%	11	10.0	7.0
DECE33J222ZC4B	6300	2200 +80/-20%	15	10.0	7.0

# **DEC Series Specifications and Test Methods**

No.	Operating Temperature Range     Appearance and Dimensions		Specifications	Testing Method
1			-25 to +85°C	
2			No marked defect on appearance form and dimensions are within specified range.	The capacitor should be visually inspected for evidence of defect. Dimensions should be measured with slide calipers.
3			To be easily legible	The capacitor should be visually inspected.
	Dielectric Strength	Between Lead Wires	No failure	The capacitor should not be damaged when DC voltage of 200% of the rated voltage is applied between the lead wires for 1 to 5 sec. (Charge/Discharge current≦50mA)
4		Body Insulation	No failure	The capacitor is placed in the container with metal balls of diameter 1mm so that each lead wire, short circuited, is kept about 2mm off the metal balls as shown in the figure at right, and DC voltage of 1.3kV is applied for 1 to 5 sec. between capacitor lead wires and metal balls.  (Charge/Discharge current≦50mA)
5	Insulation Resistance (I.R.)	Between Lead Wires	10000MΩ min.	The insulation resistance should be measured with DC500±50V within 60±5 sec. of charging.
6	Capacitance		Within specified tolerance	The capacitance should be measured at 20°C with 1±0.2kHz (Char. SL: 1±0.2MHz) and AC5V(r.m.s.) max.
7	Q		Char. SL: 400+20C*2min. (30pF under) 1000 min. (30pF min.)	The dissipation factor and Q should be measured at 20°C with 1±0.2kHz (Char. SL: 1±0.2MHz) and AC5V(r.m.s.) max.
	Dissipation Factor	(D.F.)	Char. B, E: 2.5% max.	TEO.ZNIZ (Onal. OE. 110.ZWI1Z) and AOOV (I.III.S.) max.
			Char. SL: +350 to -1000ppm/°C (Temp. range: +20 to +85°C) Char. B: Within ±10% Char. E: Within +20/-55%	The capacitance measurement should be made at each step specified in Table.
8	Temperature Characteristics		Pre-treatment : Capacitor should be stored at 85±2°C for 1 hr., then placed at  *¹room condition for 24±2 hrs. before measurements. (Char. B, E)  Step 1 2 3 4 5  Temp. (°C) 20±2 -25±3 20±2 85±2 20±2	
9	Strength of Lead	Pull	Lead wire should not be cut off. Capacitor should not be broken.	As shown in the figure at right, fix the body of the capacitor and apply a tensile weight gradually to each lead wire in the radial direction of the capacitor up to 10N and keep it for 10±1 sec.
		Bending		Each lead wire should be subjected to 5N of weight and bent 90° at the point of egress, in one direction, then returned to its original position and bent 90° in the opposite direction at the rate of one bend in 2 to 3 sec.
		Appearance	No marked defect	The conscitor should be firmly coldered to the supporting lead
	Vibration	Capacitance	Within specified tolerance	The capacitor should be firmly soldered to the supporting lead wire and vibrated at a frequency range of 10 to 55Hz, 1.5mm in
10	Resistance	Q	Char. SL: 400+20C*2min. (30pF under) 1000 min. (30pF min.)	total amplitude, with about a 1 minute rate of vibration change from 10Hz to 55Hz and back to 10Hz. Apply for a total of 6 hrs.,
		D.F.	Char. B, E: 2.5% max.	2 hrs. each in 3 mutually perpendicular directions.
11	Solderability of Le	ads	Lead wire should be soldered with uniform coating on the axial direction over 3/4 of the circumferential direction.	The lead wire of a capacitor should be dipped into a ethanol solution of 25wt% rosin and then into molten solder for 2±0.5 sec. In both cases the depth of dipping is up to about 1.5 to 2mm from the root of lead wires.  Temp. of solder: Lead Free Solder (Sn-3Ag-0.5Cu) 245±5°C H63 Eutectic Solder 235±5°C
	Soldering Effect (Non-Preheat)	Appearance	No marked defect	The lead wire should be immersed into the melted solder of
		Capacitance Change	Char. SL: Within ±2.5% Char. B: Within ±5% Char. E: Within ±15%	350±10°C up to about 1.5 to 2mm from the main body for 3.5±0.5 sec.  Pre-treatment: Capacitor should be stored at 85±2°C for 1 hr., then placed at *1room condition for 24±2 hrs.
12		Dielectric Strength (Between Lead Wires)	Per item 4.	before initial measurements. (Char. B, E) Post-treatment: Capacitor should be stored for 1 to 2 hrs. at *'room condition. (Char. SL) Post-treatment: Capacitor should be stored for 4 to 24 hrs. at *'room condition. (Char. B, E)

<sup>\*1 &</sup>quot;room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa \*2 "C" expresses nominal capacitance value (pF)

Continued on the following page.

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# **DEC Series Specifications and Test Methods**

No.		Item	Specifications	Testing Method	
	Appearance		No marked defect	First the capacitor should be	
131		Capacitance Change	Char. SL: Within ±2.5% Char. B: Within ±5% Char. E: Within ±15%	stored at 120+0/-5°C for 60+0/-5 sec.  Then, as in figure, the lead wires should be immersed solder of	
	Soldering Effect (On-Preheat)	Dielectric Strength (Between Lead Wires)	Per item 4.	260+0/-5°C up to 1.5 to 2.0mm from the root of terminal for 7.5+0/-1 sec.  Pre-treatment: Capacitor should be stored at 85±2°C for 1 hr., then placed at *¹room condition for 24±2 hrs. before initial measurements. (Char. B, E)  Post-treatment: Capacitor should be stored for 1 to 2 hrs. at *¹room condition. (Char. SL)  Post-treatment: Capacitor should be stored for 4 to 24 hrs. at *¹room condition. (Char. B, E)	
		Appearance	No marked defect	The capacitor should be subjected to 5 temperature cycles,	
		Capacitance Change	Char. SL: Within ±3% Char. B: Within ±10% Char. E: Within ±20%	then consecutively to 2 immersion cycles. <temperature cycle=""></temperature>	
		Q	Char. SL: 275+5/2C*2min. (30pF under) 350 min. (30pF min.)	Step   Temperature (°C)   Time (min)	
		D.F.	Char. B, E: 4.0% max.	3 85±3 30	
	Temperature	I.R.	2000MΩ min.	4   Room Temp.   3 Cycle time: 5 cycle	
4	and Immersion			<mmersion cycle=""></mmersion>	
	Cycle			Step Temperature (°C) Time (min) Immersion water 1 65 +5/-0 15 Clean water	
				2 0 ±3 15 Salt water	
		Dielectric Strength (Between Lead Wires)		Cycle time: 2 cycle  Pre-treatment: Capacitor should be stored at 85±2°C for 1 hr. then placed at *¹room condition for 24±2 hrs. before initial measurements. (Char. B, E)	
				Post-treatment: Capacitor should be stored for 4 to 24 hrs. at *1room condition.	
	Humidity (Under Steady State)	Appearance	No marked defect		
		Capacitance Change	Char. SL: Within ±5% Char. B: Within ±10% Char. E: Within ±20%	Set the capacitor for 500 +24/-0 hrs. at 40±2°C in 90 to 95% relative humidity.  Pre-treatment: Capacitor should be stored at 85±2°C for 1 hr.	
15		Q	Char. SL: 275+5/2C*2min. (30pF under) 350 min. (30pF min.)	then placed at *¹room condition for 24±2 hrs before initial measurements. (Char. B, E)  Post-treatment: Capacitor should be stored for 1 to 2 hrs. a *¹room condition.	
		D.F.	Char. B, E: 5.0% max.		
		I.R.	1000MΩ min.		
		Appearance	No marked defect	Apply the rated voltage for 500 +24/-0 hrs. at 40±2°C in 90 to	
16	Humidity Loading	Capacitance Change	Char. SL: Within ±7.5% Char. B: Within ±10% Char. E: Within ±20%	95% relative humidity. (Charge/Discharge current≦50mA.)  Pre-treatment: Capacitor should be stored at 85±2°C for 1 hr.  then placed at *¹room condition for 24±2 hrs.	
		Q	Char. SL: 100+10/3C*²min. (30pF under) 200 min. (30pF min.)	before initial measurements. (Char. B, E) Post-treatment: Capacitor should be stored for 1 to 2 hrs. at  *1room condition. (Char. SL) Post-treatment: Capacitor should be stored at 85±2°C for 1 hr	
		D.F.	Char. B, E: 5.0% max.	then placed at *1room condition for 24±2 hrs.	
		I.R.	500MΩ min.	(Char. B, E)	
	Life	Appearance	No marked defect	Apply a DC voltage of 150% of the rated voltage for	
17		Capacitance Change	Char. SL: Within ±3% Char. B: Within ±10% Char. E: Within ±20%	1000 +48/-0 hrs. at 85±2°C with a relative humidity of 50% max. (Charge/Discharge current≦50mA.)  Pre-treatment: Capacitor should be stored at 85±2°C for 1 hr. then placed at *¹room condition for 24±2 hrs.	
		Q	Char. SL: 275+5/2C*2min. (30pF under) 350 min. (30pF min.)	before initial measurements. (Char. B, E) Post-treatment: Capacitor should be stored for 1 to 2 hrs. at	
		D.F.	Char D F: 4.00/	*1room condition. (Char. SL)	
		D.F.	Char. B, E: 4.0% max.	Post-treatment: Capacitor should be stored at 85±2°C for 1 hr	

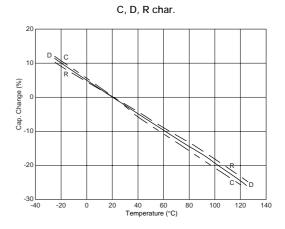
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<sup>\*2 &</sup>quot;C" expresses nominal capacitance value (pF)

# **High Voltage Ceramic Capacitors Characteristics Data (Typical Example)**

#### **■** Capacitance-Temperature Characteristics

B, E, F, SL char. Cap. Change (%) -20 -60 -80 └ -40 80



#### ■ Capacitance-DC Bias Characteristics

